



National Semiconductor

May 1999

## DS26LS32AC/DS26LS32C/DS26LS32M/DS26LS33M Quad Differential Line Receivers

### General Description

The DS26LS32 and DS26LS32A are quad differential line receivers designed to meet the RS-422, RS-423 and Federal Standards 1020 and 1030 for balanced and unbalanced digital data transmission.

The DS26LS32 and DS26LS32A have an input sensitivity of 200 mV over the input voltage range of  $\pm 7V$  and the DS26LS33 have an input sensitivity of 500 mV over the input voltage range of  $\pm 15V$ .

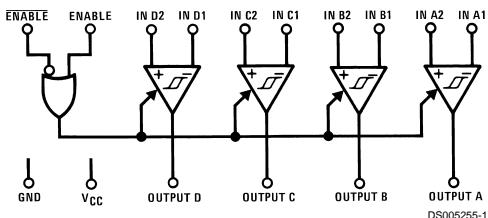
The DS26LS32A differ in function from the popular DS26LS32 and DS26LS33 in that input pull-up and pull-down resistors are included which prevent output oscillation on unused channels.

Each version provides an enable and disable function common to all four receivers and features TRI-STATE® outputs with 8 mA sink capability. Constructed using low power Schottky processing, these devices are available over the full military and commercial operating temperature ranges.

### Features

- High differential or common-mode input voltage ranges of  $\pm 7V$  on the DS26LS32 and DS26LS32A and  $\pm 15V$  on the DS26LS33
- $\pm 0.2V$  sensitivity over the input voltage range on the DS26LS32 and DS26LS32A,  $\pm 0.5V$  sensitivity on the DS26LS33
- DS26LS32 and DS26LS32A meet all requirements of RS-422 and RS-423
- 6k minimum input impedance
- 100 mV input hysteresis on the DS26LS32 and DS26LS32A, 200 mV on the DS26LS33
- Operation from a single 5V supply
- TRI-STATE outputs, with choice of complementary output enables for receiving directly onto a data bus

### Logic Diagram

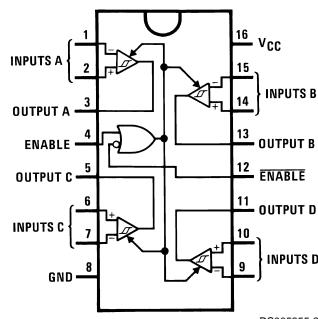


**DS26LS32AC/DS26LS32C/DS26LS32M/DS26LS33M Quad Differential Line Receivers**

TRI-STATE® is a registered trademark of National Semiconductor Corporation.

## Connection Diagram

Dual-In-Line Package



DS005255-2

Top View

Order Number DS26LS32CM, DS26LS32CN,  
DS26LS32ACM, DS26LS32ACN, DS26LS33ACM  
or DS26LS33ACN

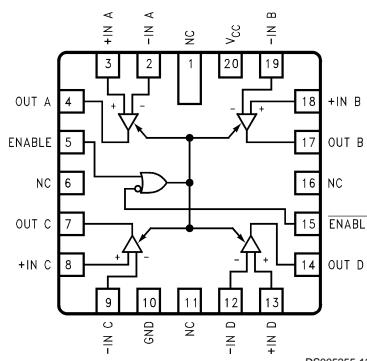
See NS Package Number M16A or N16E

For Complete Military Product Specifications,  
refer to the appropriate SMD or MDS.

Order Number DS26LS32MJ/883, DS26LS32MW/883,  
DS26LS32ME/883, DS26LS33MW/883

See NS Package Number E20A, J16A or W16A

20-Lead Ceramic Leadless Chip Carrier



DS005255-12

## Truth Table

ENABLE	$\overline{\text{ENABLE}}$	Input	Output
0	1	X	Hi-Z
See Note Below		$V_{ID} \geq V_{TH} (\text{Max})$	1
		$V_{ID} \leq V_{TH} (\text{Min})$	0

Hi-Z = TRI-STATE®

Note: Input conditions may be any combination not defined for ENABLE and  $\overline{\text{ENABLE}}$ .

<b>Absolute Maximum Ratings</b> (Note 3)		<b>Operating Conditions</b>			
If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.					
Supply Voltage	7V	Supply Voltage, ( $V_{CC}$ )	Min	Max	Units
Common-Mode Range	$\pm 25V$	DS26LS32M, DS26LS33M (MIL)	4.5	5.5	V
Differential Input Voltage	$\pm 25V$	DS26LS32C	4.75	5.25	V
Enable Voltage	7V	DS26LS32AC (COML)			
Output Sink Current	50 mA	Temperature, ( $T_A$ )			
Maximum Power Dissipation (Note 1) at 25°C		DS26LS32M, DS26LS33M	-55	+125	°C
Cavity Package	1433 mW	(MIL)			
Molded Dip Package	1362 mW	DS26LS32C	0	+70	°C
SO Package DS26LS32	1002 mW	DS26LS32AC			
DS26LS32A	1051 mW	(COML)			
Storage Temperature Range	-65°C to +165°C	Note 1: Derate cavity package 9.6 mW/°C above 25°C; derate molded DIP package 10.9 mW/°C above 25°C.			
Lead Temperature (Soldering, 4 seconds)	260°C	Note 2: Derate SO Package 8.01 mW/°C for DS26LS32 8.41 mW/°C for DS26LS32A			
<b>Electrical Characteristics</b> (Notes 4, 5, 6)					
over the operating temperature range unless otherwise specified					
Symbol	Parameter	Conditions		Min	Typ
$V_{TH}$	Differential Input Voltage	$V_{OUT} = V_{OH}$	$DS26LS32, DS26LS32A, -7V \leq V_{CM} \leq +7V$	-0.2	$\pm 0.07$
		$V_{OL}$	$DS26LS33, DS26LS33A, -15V \leq V_{CM} +15V$	-0.5	$\pm 0.14$
$R_{IN}$	Input Resistance	$-15V \leq V_{CM} \leq +15V$ (One Input AC GND)		6.0	8.5
$I_{IN}$	Input Current (Under Test)	$V_{IN} = 15V$ , Other Input $-15V \leq V_{IN} \leq +15V$			2.3 mA
		$V_{IN} = -15V$ , Other Input $-15V \leq V_{IN} \leq +15V$			-2.8 mA
$V_{OH}$	Output High Voltage	$V_{CC} = \text{MIN}, \Delta V_{IN} = 1V, V_{ENABLE} = 0.8V, I_{OH} = -440 \mu A$		Commercial	2.7 4.2
		Military		2.5	4.2
$V_{OL}$	Output Low Voltage	$V_{CC} = \text{Min}, \Delta V_{IN} = -1V, V_{ENABLE} = 0.8V$		$I_{OL} = 4 \text{ mA}$	0.4 V
		$V_{CC} = \text{Max}, \Delta V_{IN} = -1V, V_{ENABLE} = 0.8V$		$I_{OL} = 8 \text{ mA}$	0.45 V
$V_{IL}$	Enable Low Voltage				
$V_{IH}$	Enable High Voltage				
$V_I$	Enable Clamp Voltage	$V_{CC} = \text{Min}, I_{IN} = -18 \text{ mA}$			
$I_O$	OFF-State (High Impedance) Output Current	$V_{CC} = \text{Max}$		$V_O = 2.4V$	20 $\mu A$
		$V_O = 0.4V$			-20 $\mu A$
$I_{IL}$	Enable Low Current	$V_{IN} = 0.4V$			
$I_{IH}$	Enable High Current	$V_{IN} = 2.7V$			
$I_{SC}$	Output Short-Circuit Current	$V_O = 0V, V_{CC} = \text{Max}, \Delta V_{IN} = 1V$		-15	-85 mA
$I_{CC}$	Power Supply Current	$V_{CC} = \text{Max}, \text{All } V_{IN} = \text{GND}, \text{ Outputs Disabled}$		DS26LS32, DS26LS32A	52 70 mA
		DS26LS33, DS26LS33A			57 80 mA
$I_I$	Input High Current	$V_{IN} = 5.5V$			
$V_{HYST}$	Input Hysteresis	$T_A = 25^\circ C, V_{CC} = 5V, V_{CM} = 0V$	DS26LS32, DS26LS32A	100	mV
		DS26LS33, DS26LS33A		200	mV

Note 3: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Note 4: All currents into device pins are shown as positive, all currents out of device pins are shown as negative, all voltages are referenced to ground, unless otherwise specified. All values shown as max or min are so classified on absolute value basis.

Note 5: All typical values are  $V_{CC} = 5V, T_A = 25^\circ C$ .

Note 6: Only one output at a time should be shorted.

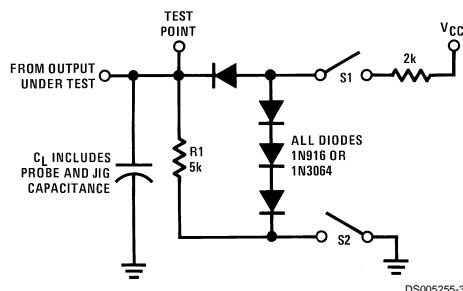
## Switching Characteristics

$V_{CC} = 5V$ ,  $T_A = 25^\circ C$

Symbol	Parameter	Conditions	DS26LS32/DS26LS33			DS26LS32A/DS26LS33A			Units
			Min	Typ	Max	Min	Typ	Max	
$t_{PLH}$	Input to Output	$C_L = 15 \text{ pF}$		17	25		23	35	ns
$t_{PHL}$				17	25		23	35	ns
$t_{LZ}$	ENABLE to Output	$C_L = 5 \text{ pF}$		20	30		15	30	ns
$t_{HZ}$				15	22		20	25	ns
$t_{ZL}$	ENABLE to Output	$C_L = 15 \text{ pF}$		15	22		14	22	ns
$t_{ZH}$				15	22		15	22	ns

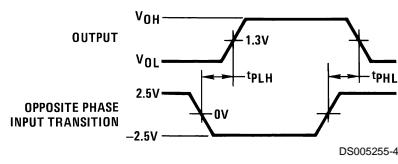
## AC Test Circuit and Switching Time Waveforms

Load Test Circuit for TRI-STATE® Outputs



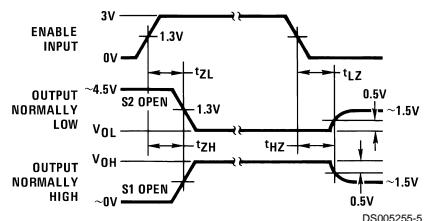
DS005255-3

Propagation Delay (Notes 7, 9)



DS005255-4

Enable and Disable Times (Notes 8, 9)



DS005255-5

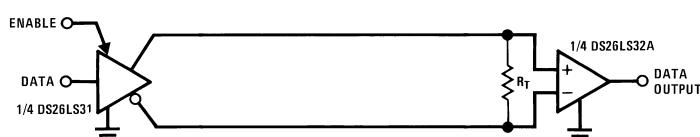
Note 7: Diagram shown for ENABLE low.

Note 8: S1 and S2 of load circuit are closed except where shown.

Note 9: Pulse generator for all pulses: Rate = 1.0 MHz;  $Z_O = 50\Omega$ ;  $t_f \leq 6 \text{ ns}$ ;  $t_r \leq 6.0 \text{ ns}$ .

## Typical Applications

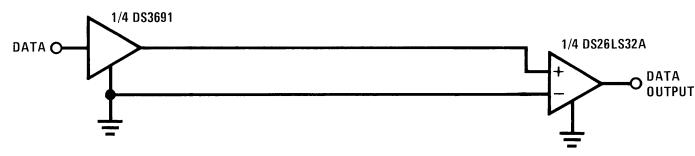
Two-Wire Balanced Interface—RS-422



DS005255-6

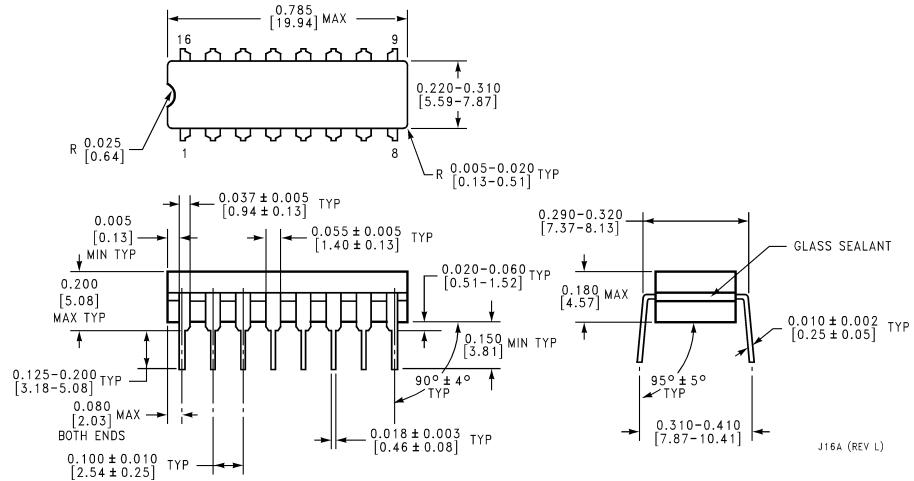
## Typical Applications (Continued)

Single Wire with Driver Ground Reference—RS-423

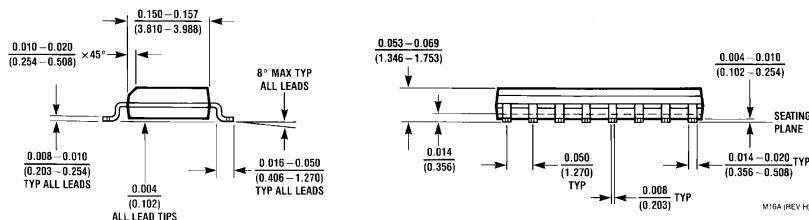
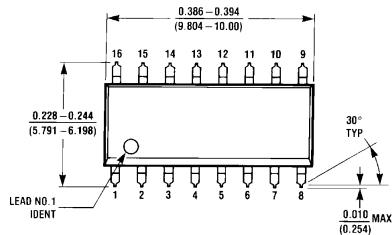


DS005255-7

**Physical Dimensions** inches (millimeters) unless otherwise noted

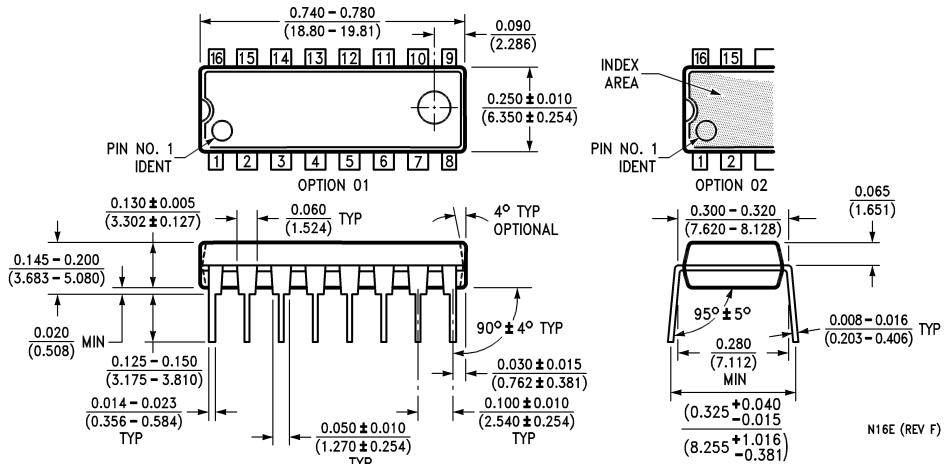


**Ceramic Dual-In-Line Package (J)  
Order Number DS26LS32MJ/883 or DS26LS33MJ/883  
NS Package Number J16A**

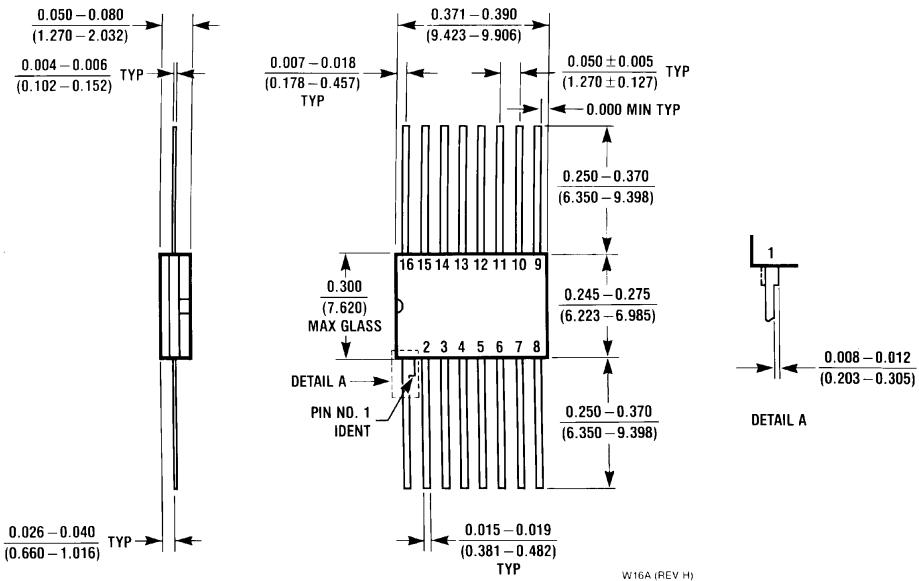


**Small Outline Package (M)**  
**Order Number DS26LS32CM or DS26LS32ACM**  
**NS Package Number M16A**

**Physical Dimensions** inches (millimeters) unless otherwise noted (Continued)



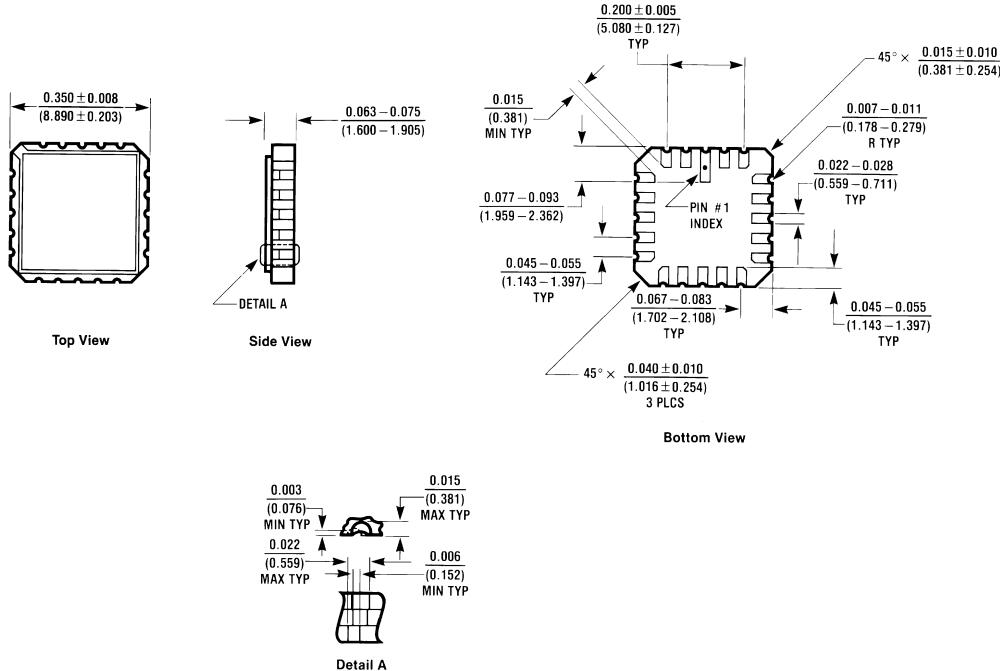
**Molded Dual-In-Line Package (N)**  
Order Number DS26LS32CN or DS26LS32ACN  
NS Package Number N16E



**16 Lead Ceramic Flatpak (W)**  
Order Number DS26LS32MW/883 or DS26LS33MW/883  
NS Package Number W16A

# DS26LS32AC/DS26LS32C/DS26LS32M/DS26LS33MQuad Differential Line Receivers

## Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



E20A (REV D)

**20 Lead Ceramic Leadless Chip Carrier (E)  
Order Number DS26LS32ME/883  
NS Package Number E20A**

### LIFE SUPPORT POLICY

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